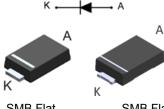


STTH2L06-Y

Datasheet

Automotive 2 A - 600 V turbo 2 ultrafast rectifier



SMB Flat

SMB Flat Wettable leads

Features

- AEC-Q101 qualified
- Ultrafast recovery •
- Low switching losses
- High surge capability •
- Low leakage current •
- High junction temperature •
- ECOPACK2 or ECOPACK3 compliant component on demand
- V_{RRM} guaranteed from -40 to +175 °C •

Description

•

The STTH2L06-Y is an ultrafast recovery power rectifier dedicated to energy recovery in automotive application housed in SMB Flat to improve space saving. It is especially designed for clamping function in energy recovery block.

The compromise between forward voltage drop and recovery time offers optimized performances.



Product status link STTH2L06-Y

Product summary				
I _{F(AV)}	2 A			
V _{RRM}	600 V			
T _j (max.)	175 °C			
V _F (typ.)	0.9 V			
T _{rr} (typ.)	50 ns			

1 Characteristics

Table 1. Absolute ratings (limiting values at T_j= 25 °C, unless otherwise specified)

Symbol	Parameter	Value	Unit
V _{RRM}	Repetitive peak reverse voltage, T_{j} = -40 to +175 $^{\circ}\text{C}$	600	V
I _{F(AV)}	Average forward current	2	А
I _{FSM}	Forward surge current	30	А
T _{stg}	Storage temperature range	-65 to + 175	°C
T _j ⁽¹⁾	Operating temperature range	-40 to + 175	°C

1. $(dP_{tot'}/dT_j) < (1/R_{th(j-a)})$ condition to avoid thermal runaway for a diode on its own heatsink.

Table 2. Thermal resistance

Symbol	Parameter	Value	Unit
R _{th(j-l)}	Junction to lead	18	°C/W

Table 3. Static electrical characteristic

Symbol	Parameter	Test co	Min.	Тур.	Max.	Unit	
I _R ⁽¹⁾			V _R = 600 V	-		2	
'R`'	I _R ⁽¹⁾ Reverse leakage current	T _j = 125 °C	vR - 000 v	-	12	85	μA
VF ⁽²⁾	Forward valtage drep	T _j = 25 °C	I _F = 2 A	-		1.4	V
v F/	V _F ⁽²⁾ Forward voltage drop			-	0.9	1.15	v

1. Pulsetest: tp = 5 ms, $\delta < 2\%$

2. Pulsetest: $tp = 380 \ \mu s, \ \delta < 2\%$

To evaluate the conduction losses use the following equation:

 $P = 0.95 \text{ x } I_{F(AV)} + 0.10 I_{F^2(RMS)}$

Table 4. Dynamic electrical characteristics

Symbol	Parameter	Test conditions		Min.	Тур.	Max.	Unit
t _{rr}	Reverse recovery time	T _j = 25 °C	I_F = 1 A; $dI_{F/dt}$ = -50 A/µs; V_R = 30 V	-	50	70	
t _{fr}	Forward recovery time	T 25 °C	I _F = 2 A; dI _{F/dt} = 100 A/μs; V _{FR} = 2.5 V	-		80	ns
V _{FP}	Forward recovery voltage	1 - 25 0		-		7	V



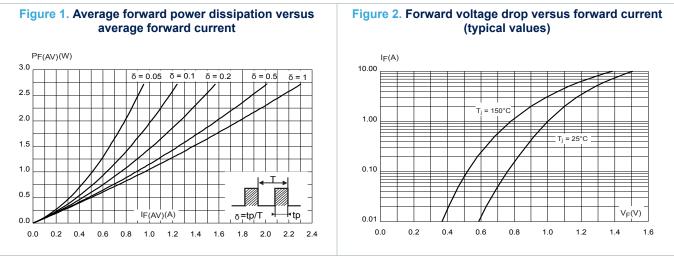


Figure 3. Forward voltage drop versus forward current (maximum values)

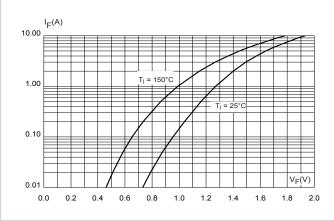
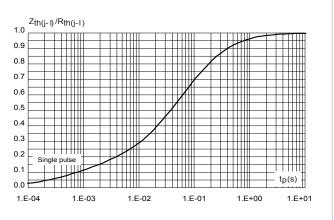
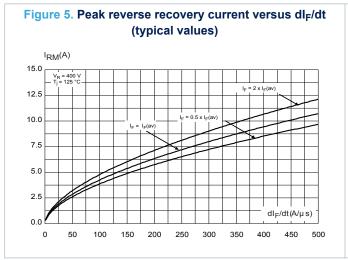
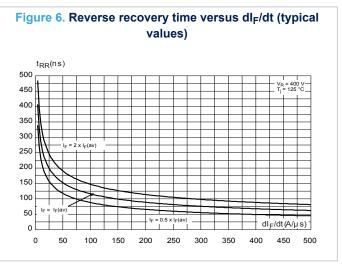
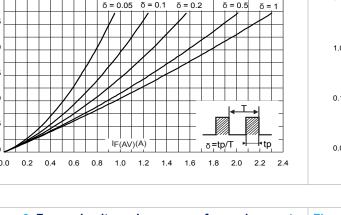


Figure 4. Relative variation of thermal impedance junction to lead versus pulse duration



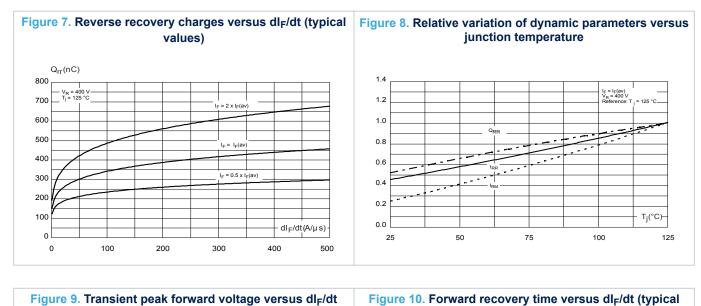


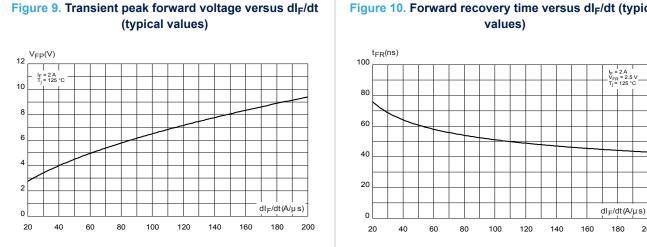












V_R(V)

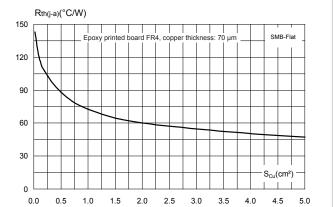
1000

100

Figure 11. Junction capacitance versus reverse voltage applied (typical values) C(pF) 100

10

Figure 12. Thermal resistance junction to ambient versus copper surface under each lead



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2 Package information

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK packages, depending on their level of environmental compliance. ECOPACK specifications, grade definitions and product status are available at: www.st.com. ECOPACK is an ST trademark.

2.1 SMB Flat package information

- Epoxy meets UL94, V0
- Lead-free package

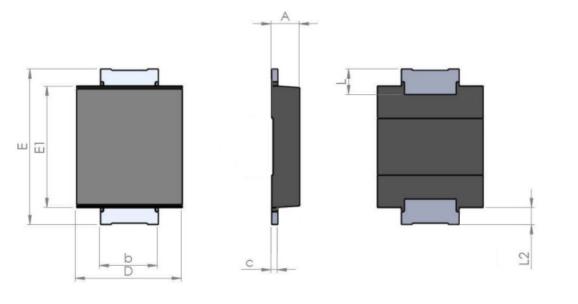


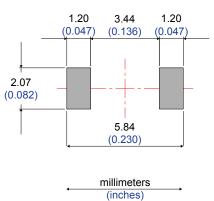
Figure 13. SMB Flat package outline

Table 5. SMB Flat mechanical data

	Dimensions						
Ref.		Millimeters		Inches			
	Min.	Тур.	Max.	Min.	Тур.	Max.	
А	0.90		1.10	0.035		0.043	
b	1.95		2.20	0.077		0.087	
С	0.15		0.40	0.006		0.016	
D	3.30		3.95	0.130		0.156	
E	5.10		5.60	0.200		0.220	
E1	4.05		4.60	0.159		0.181	
L	0.75		1.50	0.030		0.060	
L2		0.60			0.024		



Figure 14. Footprint recommendations, dimensions in mm (inches)



DS10490 - Rev 2 Downloaded from Arrow.com.



3 Ordering information

Order code	Marking	Package	Weight	Base qty.	Delivery mode
STTH2L06UFY	F2L6Y	SMBflat	50 mg	5000	Tape and reel

Revision history

Table 6. Document revision history

Date	Version	Changes
04-Aug-2014	1	Initial release.
26-Apr-2022	2	Updated Section 2.1 SMB Flat package information.

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